XP162A12A6PR-G

Power MOSFET

■GENERAL DESCRIPTION

The XP162A12A6PR-G is a P-channel Power MOSFET with low on-state resistance and ultra high-speed switching characteristics. Because high-speed switching is possible, the IC can be efficiently set thereby saving energy.

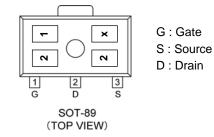
A gate protect diode is built-in to prevent static damage.

The small SOT-89 package makes high density mounting possible.

APPLICATIONS

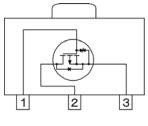
- Notebook PCs
- Cellular and portable phones
- On-board power supplies
- Li-ion battery systems

PIN CONFIGURATION/ MARKING



* x represents production lot number.

■EQUIVALENT CIRCUIT



P-channel MOSFET (1 device built-in)

■FEATURES

Low On-State Resistance : $Rds(on) = 0.17 \Omega @ Vgs = -4.5V$: $Rds(on) = 0.3 \Omega @ Vgs = -2.5V$ Ultra High-Speed Switching Dribing Voltage : -2.5VGate Protect Diode Built-in P-Channel Power MOSFET DMOS Structure Small Package : SOT-89 Environmentally Friendly : EU RoHS Compliant, Pb Free

■ PRODUCT NAME

PRODUCTS	PACKAGE	ORDER UNIT
XP162A12A6PR	SOT-89	1,000/Reel
XP162A12A6PR-G ^(*)	SOT-89	1,000/Reel

^(*) The "-G" suffix denotes Halogen and Antimony free as well as being fully RoHS compliant.

■ABSOLUTE MAXIMUM RATINGS

		Ta	a = 25°C
PARAMETER	SYMBOL	RATINGS	UNITS
Drain-Source Voltage	Vdss	-20	V
Gate-Source Voltage	Vgss	±12	V
Drain Current (DC)	ld	-2.5	А
Drain Current (Pulse)	ldp	-10	А
Reverse Drain Current	ldr	-2.5	А
Channel Power Dissipation *	Pd	2	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	-55~150	°C

* When implemented on a ceramic PCB

■ELECTRICAL CHARACTERISTICS

DC Characteristics

DC Characteristics					Т	a = 25°C
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Drain Cut-Off Current	ldss	Vds= -20V, Vgs= 0V	-	-	-10	μA
Gate-Source Leak Current	lgss	Vgs= \pm 12V, Vds= 0V	-	-	±10	μA
Gate-Source Cut-Off Voltage	Vgs(off)	Id= -1mA, Vds= -10V	-0.5	-	-1.2	V
Drain-Source On-State Resistance*1	Rds(on)	ld= -1.5A, Vgs= -4.5V	-	0.13	0.17	Ω
		ld= -1.5A, Vgs= -2.5V	-	0.22	0.30	Ω
Forward Transfer Admittance*1	Yfs	ld= -1.5A, Vds= -10V	-	4	-	S
Body Drain Diode Forward Voltage	Vf	lf= -2.5A, Vgs= 0V	-	-0.85	-1.1	V

*1 Effective during pulse test.

Dynamic Characteristics

•					•	u - 20 0
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Input Capacitance	Ciss	Vds= -10V, Vgs=0V f= 1MHz	-	310	-	pF
Output Capacitance	Coss		-	200	-	pF
Feedback Capacitance	Crss		-	90	-	pF

Switching Characteristics

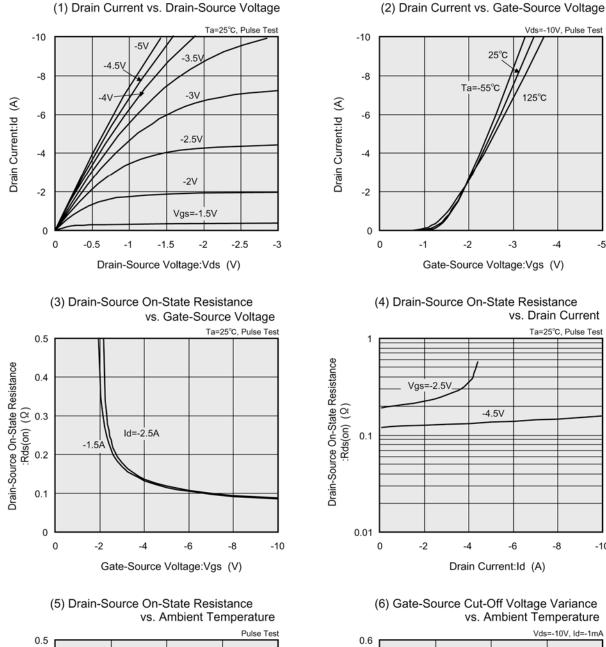
Switching Characteristics					Т	a = 25°C
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Turn-On Delay Time	td (on)	Vgs= -5V, Id= -1.5A Vdd= -10V	-	5	-	ns
Rise Time	tr		-	15	-	ns
Turn-Off Delay Time	td (off)		-	55	-	ns
Fall Time	tf		-	55	-	ns

Thermal Characteristics

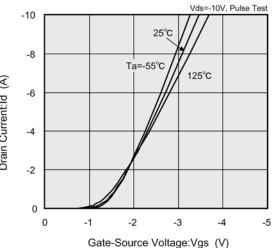
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Thermal Resistance (Channel-Ambience)	Rth (ch-a)	Implement on a ceramic PCB	-	62.5	-	°C/W

Ta = 25°C

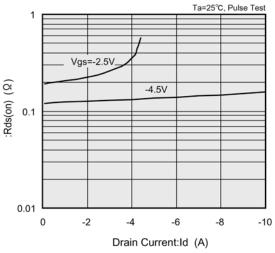


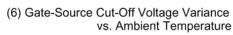


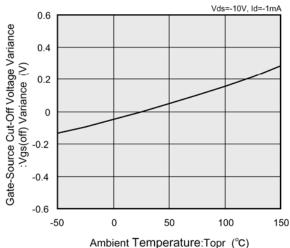
ld =-2.5A as =-2.5V -1.5A -2.5A -1.5A -4.5V 0 0 50 100 150 -50 Ambient Temperature:Topr (°C)



(4) Drain-Source On-State Resistance vs. Drain Current

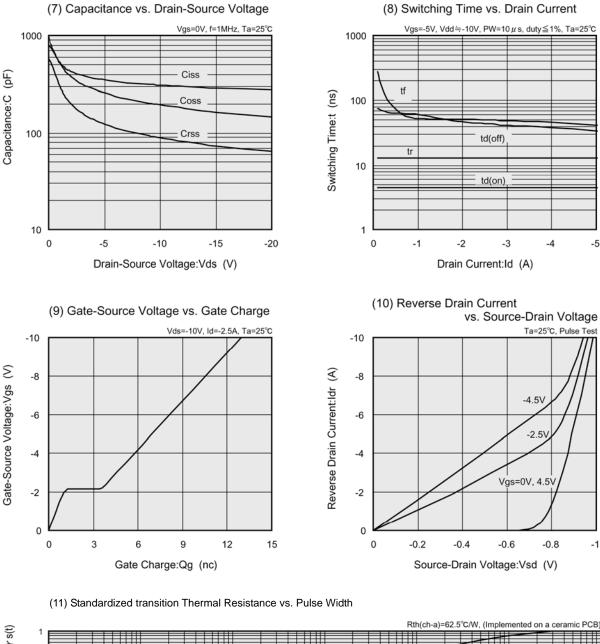


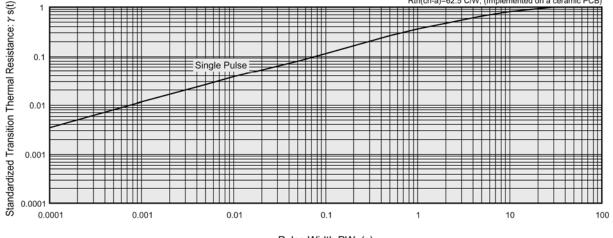




TOIREX

■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)





 ${\sf Pulse Width:}{\sf PW} \ \ (s)$

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